

# Modular Jacks, unshielded

PCB, Low Profile



## SPECIFICATION:

Current rating: 1.5 A  
Insulation resistance: 500 MΩ min.  
Contact resistance: 40 mΩ max.  
Dielectric voltage: 1000 V AC  
Operation temperature: 0 °C to +70 °C

## MATERIAL:

Housing: PBT UL94V-0  
Contacts: Phosphorbronze  
Solder pins: Phosphorbronze

## FINISH:

Contacts: Gold over nickel  
Solder pins: Tin over nickel

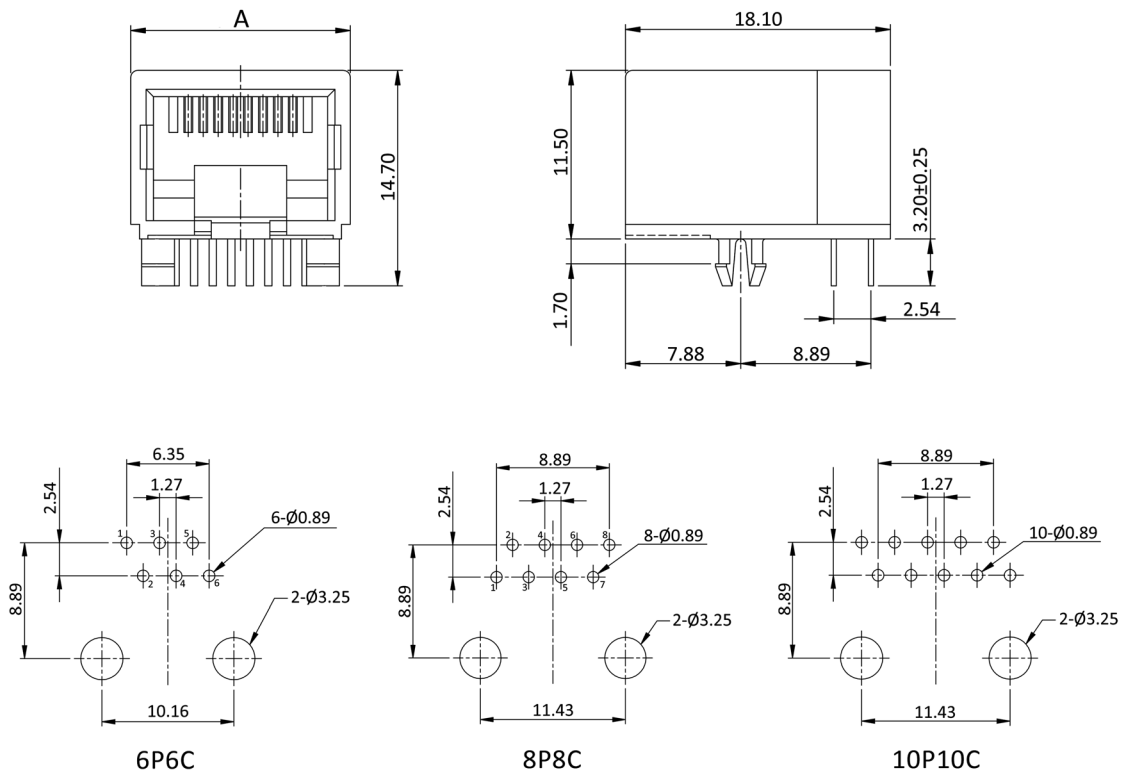
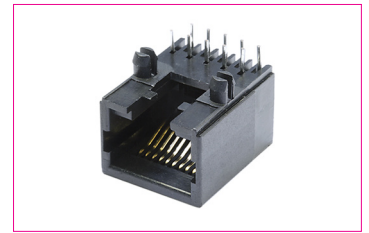
## HANDLING:

Processing: Wave soldering  
Packing: Tray

## TOLERANCE:

.X ± 0.38  
.XX ± 0.25

RoHS  
COMPLIANT



## Dimensions

Positions:	A
6	12.96
8	15.00
10	15.00

## Order-Information

Identifier:	Positions:	Conductors:	Contact Plating:
MEB	# /	# PL	#
Modular Jack low profile, unshielded, PCB mount	6: 6P 8: 8P 10: 10P	6: 6C 8: 8C 10: 10C	empty: 6 µ" Gold * B: 15 µ" Gold C: 30 µ" Gold D: 50 µ" Gold

\* = standard